FORM PTO-1595 1-31-92

12-10-1998 100916549

₹ SHEET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office
Attorney Docket No: WSMC113039

l. Name of conveying party:	2. Name and address of receiving party:			
Chien-Jung Wang Additional name(s) of conveying party(ies) attached? Yes X No	Name: Worldwide Semiconductor Manufacturing Corporatio Address: No. 25, Li-Hsin Rd., Science-Based Industrial Park			
3. Nature of conveyance: X Assignment	City: Hsinchu State: Taiwan Country: R.O.C. Additional name(s) & address(es) attached? Yes X No			
4. Application number(s) or patent number(s):				
A. Patent Application No(s).	B. Patent No(s).			
Additional numbers a	ttached? Yes XNo			
If this document is being filed together with a new applicatio	n, the execution date of the application is: November 10, 1998			
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1			
Chun M. Ng, Esq. CHRISTENSEN O'CONNOR JOHNSON & KINDNESSPLLC 1420 Fifth Avenue Suite 2800 Seattle, WA 98101-2347 (206) 682-8100	7. Total fee (37 C.F.R. 3.41):			
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 Statement and signature: To the best of my knowledge and belief, the foregoing informoriginal document. 	nation is true and correct and any attached copy is a true copy of the			
Chun M. Ng	11/3/28			
Name of Attorney or Agent Registration No. 36,878	Signature Date			
Direct Dial (206) 695-1719 Total nu	mber of pages including cover sheet, attachments and document: 3			

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Attorney Docket No. WSMC-1-13039

ASSIGNMENT

WHEREAS, I, Chien-Jung Wang, residing at No. 35, Alley 11, Ln. 452, Pao-

San Road, Hsinchu, Taiwan, R.O.C., am the inventor named in an application for Letters

Patent of the United States, entitled Method for forming a planar intermetal dielectric using a

barrier layer, executed on Assets 1998;

AND, WHEREAS, Worldwide Semiconductor Manufacturing Corporation, a

Taiwan corporation, having a principal place of business at No. 25, Li-Hsin Road, Science-

Based Industrial Park, Hsinchu, Taiwan, R.O.C. (hereinafter referred to as ASSIGNEE), is

desirous of acquiring my entire right and title to and interest in my invention disclosed in said

application;

NOW, THEREFORE, for sufficient, good and valuable consideration, the

receipt of which is hereby acknowledged, I do hereby sell, assign and transfer unto

ASSIGNEE my entire right and title to and interest in said application and said invention,

including the right to apply for international patents and patents thereon in foreign countries

in my name or in the name of ASSIGNEE, said invention and all applications and patents on

said invention to be held and enjoyed by ASSIGNEE as entirely as the same would have been

held and enjoyed by me had this sale, assignment and transfer not been made, and I do hereby

further agree and promise to execute all instruments and render all such assistance as

ASSIGNEE may request in order to make and prosecute any and all applications on said

invention, to enforce any and all patents on said invention, and to confirm in ASSIGNEE

legal title to said invention and all applications and patents on said invention, all without

charge to ASSIGNEE but at no expense to me.

--continued--

PATENT REEL: 9622 FRAME: 0875

Executed at Hsinchu,	Taiwan, this	10	day of	Nev
Direction of Indiana,	- wi, v			

19 78.

RECORDED: 11/30/1998

Chien-Jung Wang
Chien-Jung Wang

PATENT REEL: 9622 FRAME: 0876